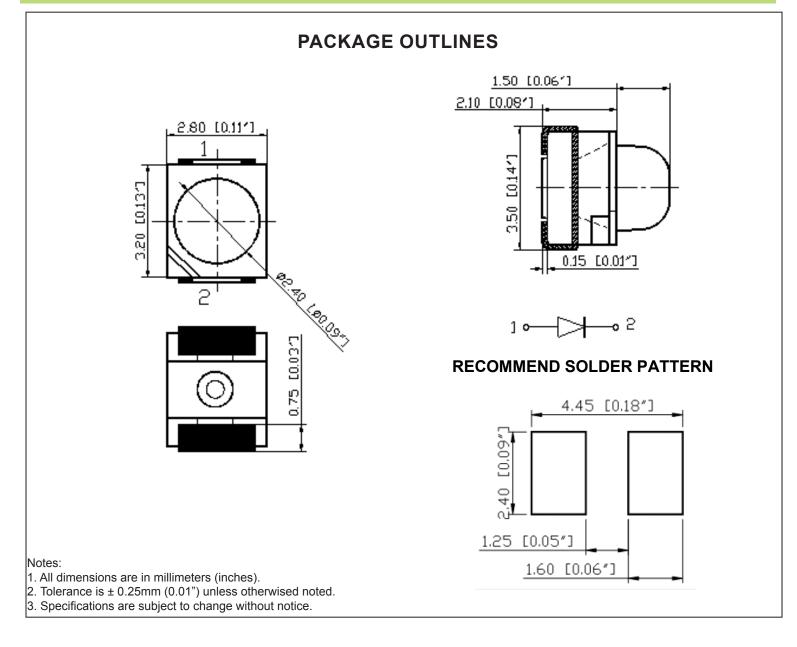


SPECIFICATION

CSPD136Y2C-2



Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle	
CSPD136Y2C-2	InGaAlP	Yellow	Water Clear	30°	





ABSOLUTE MAXIMUM RATINGS

(TA=25°C

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	30	mA	
Reverse Current @ 5V	lR	10	μΑ	
Power Dissipation	Pd	75	mW	
Operating Temperature Range	Тор	-40~+85	°C	
Storage Temperature Range	Тѕтс	-40~+85	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lfp	125	mA	
Soldering Temperature	TSOL	Max 265°C for 10 sec Max		

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Deremeter	Symbol	Test Condition	Value			Unit
Parameter		Test Condition	Min	Тур	Max	Unit
Luminous Intensity	١v	IF = 20mA	3200	5600	-	mcd
Forward Voltage	Vf	IF = 20mA	-	2.0	2.5	V
Reverse Leakage Current	lr	VR = 5V	-	-	10	μA
Viewing Angle at 50% Iv	201/2	IF = 10mA	-	30	-	Deg
Peak Wavelength	λP	IF = 20mA	-	595	-	nm
Dominant Wavelength	λD	IF = 20mA	585	590	595	nm

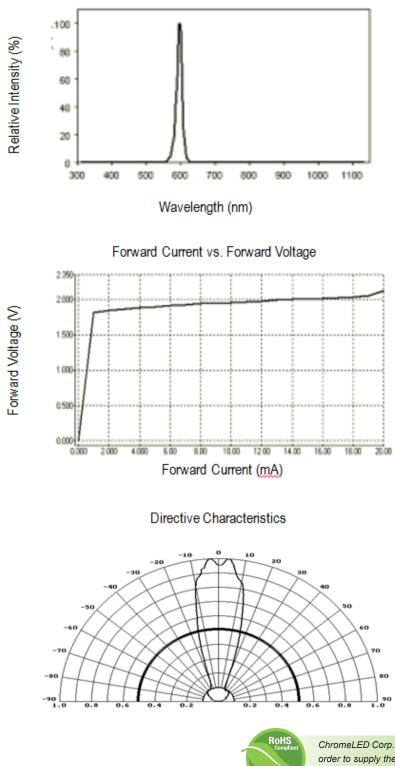
*Tolerance of viewing angle: -10 / +5 deg.





OPTICAL CHARACTERISTIC CURVES

Relative Intensity vs. Wavelength



ChromeLED Corp. reserves the right to make changes at any time in order to supply the best product possible. The most current version of this document will always be available at: www.chromeled.com

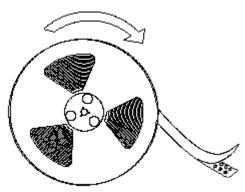
Lead Fre



PACKAGING SPECIFICATION

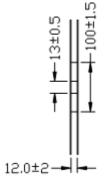
PACKAGING SPECIFICATIONS

Feeding Direction

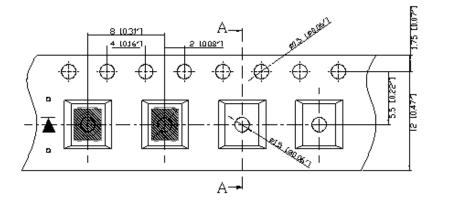


• Dimensions of Tape (unit: mm)

• Dimensions of Reel (unit: mm)

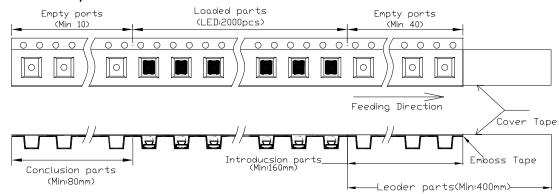








Arrangement of Tape



Notes:

- 1. Empty component pockets are sealed with top cover tape
- 2. The maximum number of missing lamps is two.
- 3. 2000 pcs/reel

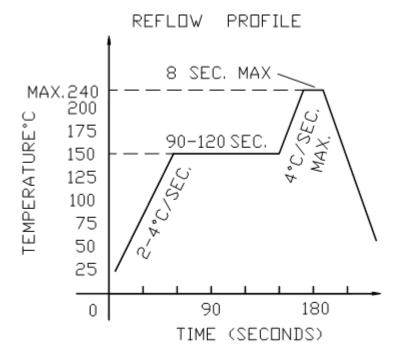




SOLDERING CONDITIONS

REFLOW PROFILE

Reflow Temp/Time



Soldering Iron

Basic spec is \leq 5 sec when 260 °C. If temperature is higher, time should be shorter (+10 °C \rightarrow -1sec). Power dissipation of iron should be smaller than 20W and temperature should be controllable. Surface temperature of the device should be under 230 °C.

